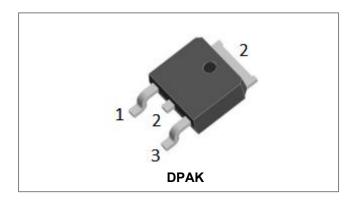


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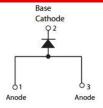
MBRD560 THRU MBRD5200 SCHOTTKY RECTIFIER



Features

- 150℃ T_J operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- · Additional testing can be offered upon request

Circuit Diagram



Applications

- Disk drives
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

Maximum Ratings and Electrical characteristics @TA = 25°C unless otherwise specified

Characteristics	Symbol	MBRD 560	MBRD 580	MBRD 5100	MBRD 5150	MBRD 5200	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	80	100	150	200	V
Max. Average Forward Current	I _{F(AV)}	5		Α			
Max. Peak One Cycle Non-Repetitive Surge Current(8.3ms Single half sine-wave)	I _{FSM}	120		Α			
Max. Forward Voltage Drop @5A, 25°C	V_{F}	0.65	0.75	0.85	0.90	0.92	V
Max. Reverse Current @VRWM, 25°C	I_R			1			mA
Max. Junction Capacitance(Note1)	Ст	300 150		pF			
Max. Junction Temperature	T_J	-55 to +150		°C			
Max. Storage Temperature	T_{stg}	-55 to +150		°C			
Typical Thermal Resistance Junction to Case (DC operation)	$R_{ heta JC}$	6.0			°C/W		
Approximate Weight	wt	wt 0.39 g		g			
Case Style	DPAK						

^{*} Pulse width < 300 μ s, duty cycle < 2%

Note1: Measured at 1.0 MHz and applied reverse voltage of 5.0V D.C.

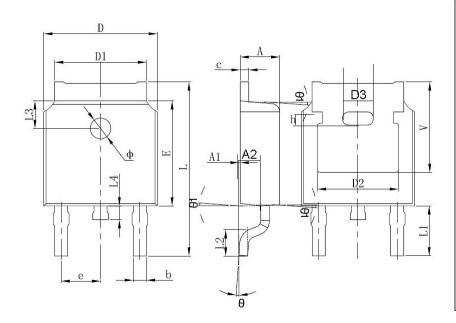


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Mechanical Dimensions DPAK



SYMBOL	Millim	neters	Inches		
STIMBUL	Min.	Min. Max.		Max.	
Α	2.20	2.40	0.087	0.094	
A1	0.00	0.127	0.000	0.005	
b	0.66	0.86	0.026	0.034	
С	0.46	0.60	0.018	0.024	
D	6.50	6.70	0.256	0.264	
D1	5.13	5.46	0.202	0.215	
D2	4.83 REF.		0.190 REF.		
Е	6.00	6.20	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.70	10.40	0.381	0.409	
L1	2.90 REF.		0.144 REF.		
L2	1.40	1.70	0.055	0.067	
L3	1.60 REF.		0.063 REF.		
L4	0.60	1.00	0.024	0.039	
Ф	1.10	1.30	0.043	0.051	
Θ	0°	8°	0°	8°	
h	0.00	0.30	0.000	0.012	
V	5.35 REF.		0.211 REF.		

Ordering Information

Device	Package	Shipping		
MBRD560 THRU MBRD5200	DPAK (Pb-Free)	2500pcs / reel		

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

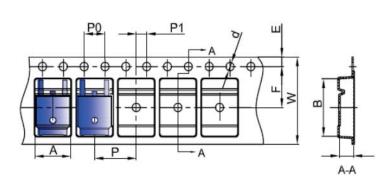
Marking Diagram



First row: Part Number (MBRD560, MBRD580, MBRD5100, MBRD5150, MBRD5200)

Second row: SSG YYWWL YY is the manufacture year, WW is the manufacture week code, L is the wafer's Lot Number

Carrier Tape Specification DPAK



SYMBOL	Millimeters			
STWIDGE	Min.	Max.		
Α	6.80	7.00		
В	10.40	10.60		
С	2.60	2.80		
d	Ф1.45	Ф1.65		
E	1.65	1.85		
F	7.40	7.60		
P0	3.90	4.10		
Р	7.90	8.10		
P1	1.90	2.10		
W	15.90	16.30		

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